

BD034
Rev.E Mar.-2016

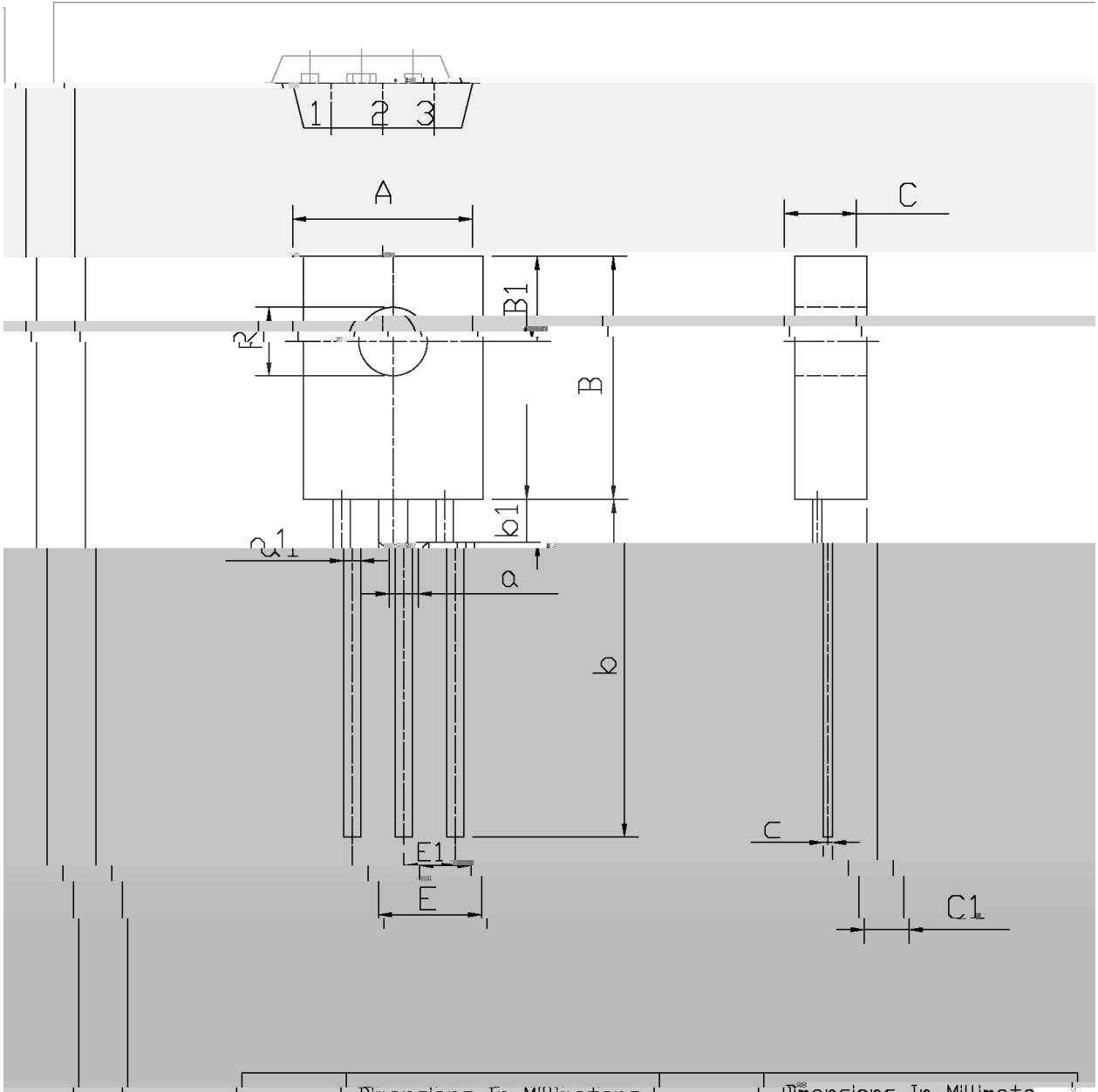
KF \$() - = GE G Silicon PNP transistor in a

BD034
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/ Package Dimensions

BU-126F

单位: mm



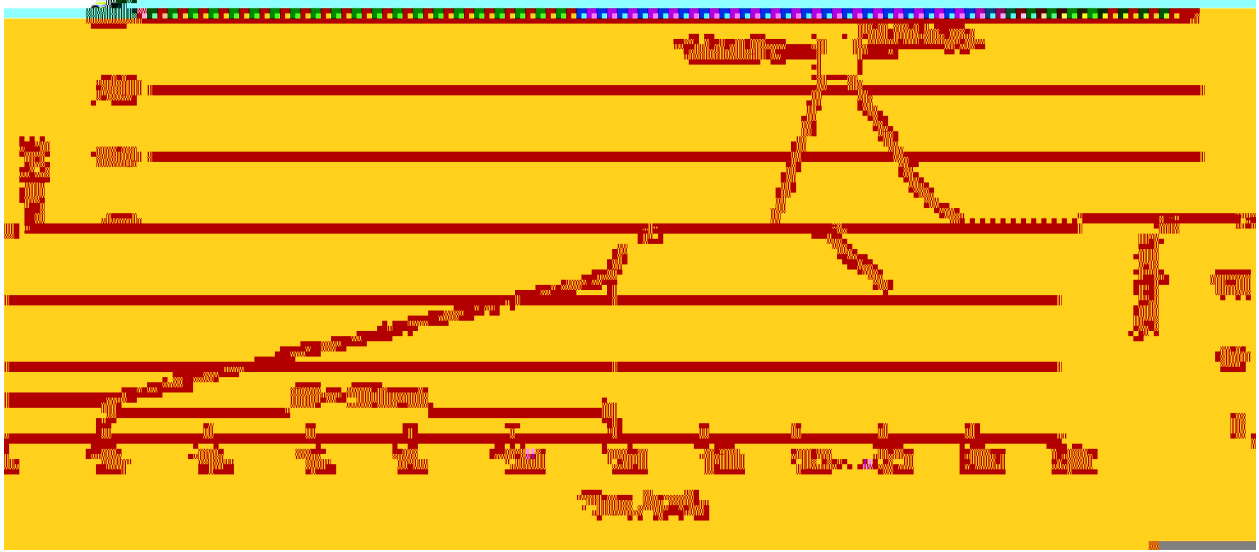
Dimensions in Millimeters		Dimensions in Millimeters		
Symbol	Min	Max	Symbol	Min
A	7.8	8.2	A1	7.8
B	10.8	11.2	B1	10.8
C	1.5	1.8	C1	1.5
E	1.5	1.8	E1	1.5
R1	0.5	0.6		

/ Marking Instructions



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- 9; ! * +
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- !!!!
- Note:
- BR: Company Code
- BD034: Product Type.
- R h_{FE} Classifications Symbol
- ****: Lot No. Code, code change with Lot No.

() / Temperature Profile for Dip Soldering(Pb-Free)



- | | | | | | | |
|---|--------|-----|------------|----------|---|--------------------------------------|
| 1 | 25 | 150 | 60 | 90sec; | Note: | 1.Preheating:25~150 , Time:60~90sec. |
| 2 | 255..5 | | 5..0.5sec; | | 2.Peak Temp.:255..5 , Duration:5..0.5sec. | |
| 3 | | | 2 | 10 /sec. | 3. Cooling Speed: 2~10 /sec. | |

/ Resistance to Soldering Heat Test Conditions

270..5 10..1 sec. Temp.:270±5 Time:10±1 sec

/ Packaging SPEC.

/ BULK

Package Type	Units	Dimension	(unit mm ³)
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